

Electronic Patent Application Fee Transmittal

Application Number:	10722193			
Filing Date:	26-Nov-2003			
Title of Invention:	INTEGRATED CIRCUIT DEVICES HAVING BURIED INSULATION LAYERS AND METHODS OF FORMING THE SAME			
First Named Inventor:	Byeong-chan Lee			
Filer:	Robert N. Crouse/Candi Riggs			
Attorney Docket Number:	5649-1225			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Utility Appt Issue fee	1501	1	1400	1400
Publ. Fee- early, voluntary, or normal	1504	1	300	300

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
Total in USD (\$)				1700